



P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(on)}	I _D T _A = +25°C
	700mΩ @ V _{GS} = -4.5V	-0.5A
-20V	900mΩ @ V _{GS} = -2.5V	-0.48A
	1300mΩ @ V _{GS} = -1.8V	-0.4A

Features and Benefits

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- **ESD Protected Gate**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(on)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

- **DC-DC Converters**
- Load Switch
- **Power Management Functions**

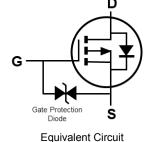
Mechanical Data

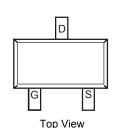
- Case: SOT523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish—Matte Tin Annealed over Alloy 42 Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Terminal Connections: See Diagram
- Weight: 0.002 grams (Approximate)











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Top View

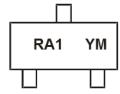
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP2900UT-7	SOT523	3000/Tape & Reel
DMP2900UT-13	SOT523	10000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



RA1 = Product Type Marking Code YM = Date Code Marking Y or \overline{Y} = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Year	2019	2020	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030
Code	G	Н		J	K	L	М	N	0	Р	R	S
	1			ı	ı			ı				
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	-20	V		
Gate-Source Voltage	V _{GSS}	±6	V		
Continuous Drain Current (Note 6) V _{GS} = -4.5V	I _D	-0.5 -0.4	Α		
Maximum Continuous Body Diode Forward Current	Is	-0.39	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)		I _{DM}	-2.5	Α

Thermal Characteristics (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)	Steady State	P_{D}	0.25	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ hetaJA}$	496	°C/W
Total Power Dissipation (Note 6)	Steady State	P _D	0.32	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ hetaJA}$	395	°C/W
Operating and Storage Temperature Range				

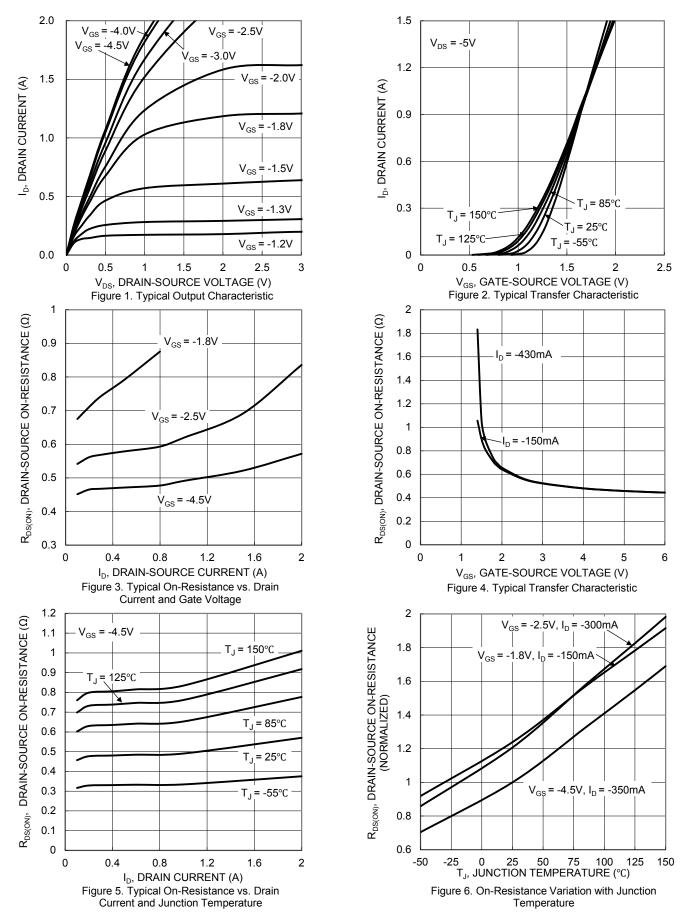
Electrical Characteristics (@ TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-20	_		V	$V_{GS} = 0V, I_D = -250\mu A$
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}		_	-100	nA	V _{DS} = -20V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}		_	±2.0	μA	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	-0.5	1	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
		1	0.4	0.7		$V_{GS} = -4.5V$, $I_D = -430mA$
Static Drain-Source On-Resistance	R _{DS(on)}		0.5	0.9	Ω	V_{GS} = -2.5V, I_{D} = -300mA
		_	0.7	1.3		$V_{GS} = -1.8V, I_D = -150mA$
Diode Forward Voltage (Note 7)	V_{SD}	_	-0.7	-1.2	V	$V_{GS} = 0V, I_{S} = -150mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}		49	_	pF	
Output Capacitance	Coss		12	_	pF	$V_{DS} = -16V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}		3.4	_	pF	1 – 1.0WH12
Total Gate Charge	Qg		0.7	_	nC	
Gate-Source Charge	Qgs		0.1	_	nC	$V_{GS} = -4.5V$, $V_{DS} = -10V$, $I_{D} = -250$ mA
Gate-Drain Charge	Q_{gd}	_	0.1	_	nC	- ID250IIIA
Turn-On Delay Time	t _{D(on)}	_	16	_	ns	
Turn-On Rise Time	t _R	_	15	_	ns	$V_{DD} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(off)}		213	_	ns	$R_L = 47\Omega, R_G = 10\Omega,$ $I_D = -200\text{mA}$
Turn-Off Fall Time	t _F	_	89	_	ns	- 1g200m/A
Reverse Recovery Time	t _{RR}	_	10.5	_	ns	1 40 11/14 4000/
Reverse Recovery Charge	Q_{RR}	_	1.8	_	nC	-I _F = -1A, di/dt = 100A/μs

Notes:

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.







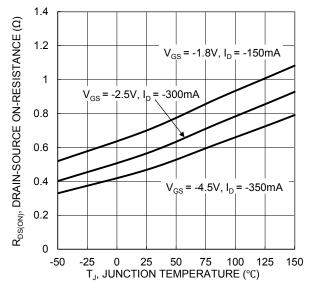


Figure 7. On-Resistance Variation with Junction Temperature

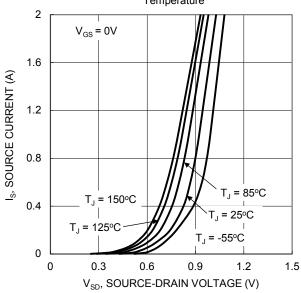
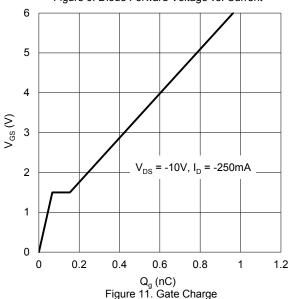


Figure 9. Diode Forward Voltage vs. Current



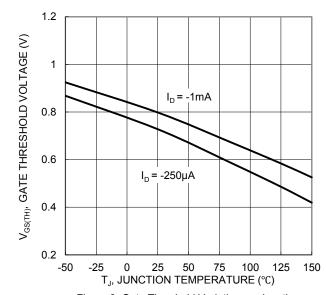


Figure 8. Gate Threshold Variation vs. Junction Temperature

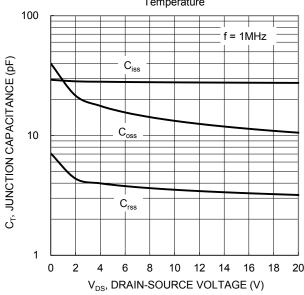
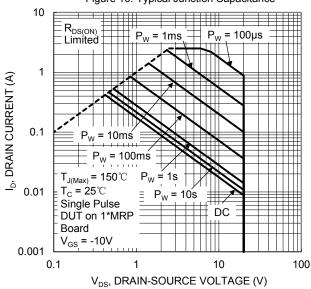


Figure 10. Typical Junction Capacitance



V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



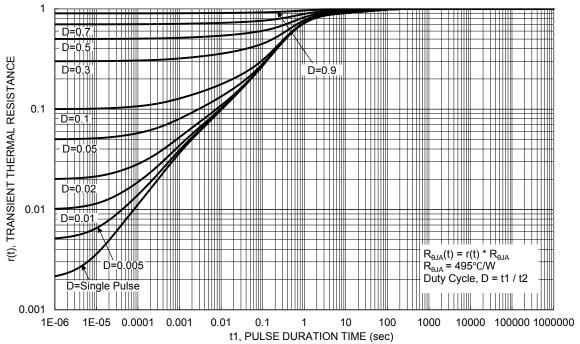


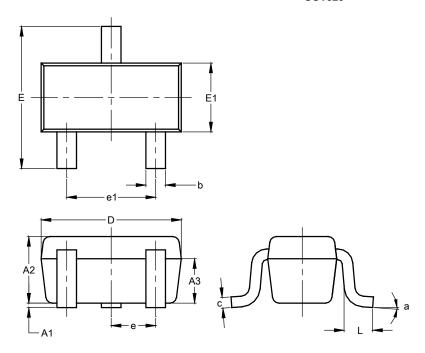
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT523

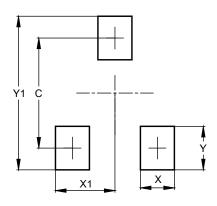


SOT523							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.60	0.80	0.75				
A3	0.45	0.65	0.50				
b	0.15	0.30	0.22				
С	0.10	0.20	0.12				
D	1.50	1.70	1.60				
E	1.45	1.75	1.60				
E1	0.75	0.85	0.80				
е	0.50 BSC						
e1	0.90	1.10	1.00				
L	0.20	0.40	0.33				
а	0°		8°				
A	All Dimensions in mm						

Suggested Pad Layout

 $\label{please} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

SOT523



Dimensions	Value (in mm)			
С	1.29			
Х	0.40			
X1	0.70			
Υ	0.51			
V1	1.80			



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